



RE933-09

- Epoxy fibre-glass FR4 1.50 mm
- Double-sided 35 µm Cu
- Plated through holes (PTH)
- Surface chem. Ni/Au with solder stop mask
- Adaption circuit board for TSSOP 48
- Pitch: 0.50 mm (240 mil)
- Hole diameter 1.00 mm
- Size 27.31 x 33.97 mm

Module-No.	Pitch	mil	Pin	Size (mm)
RE933-09	0.500 mm	19.6	48	6.100 (240 mil)